15+Gbps 0.5mm pitch Stacking Connectors

FX10 Series   Electrical Interface for the OIF 100G Long-Haul DWDM Transmission Module (MSA-100GLH)

- **Mechanical Features**
  - 0.5mm Pitch
  - Stacking height: 4 to 8mm (2-piece type)  
    8 to 13mm (3-piece type)

- **Number of Contacts**
  - With ground plate: 80 / 100 / 120 / 140
  - Without ground plate: 96 / 120 / 144 / 168
  - 3-piece interposer: 120 / 144 / 168

- **OIF MSA-100GLH Electrical Interface**
  - FX10A-168P/S-SV(83) assembly is specified for the OIF 100G Long-Haul DWDM Transmission Module host line card - MSA-100GLH electrical connector.

- **With GND Plate Type**
  - Suited to High-Density Applications
    The 0.5 mm signal contact pitch provides a smaller overall connector, using less mounting area on the board.
  - Optional Ground Plate
    An alternate style without the ground plate is available. The space provided by the ground plate removal has been filled with additional signal contacts.

- **Floating Interposer**
  - Smooth floating with high speed transmission capability supported by unique 3-piece floating system
  - Multiple connectors are allowed on the same PCB (Allowable Mis-alignment Range: ± 0.3mm in XY direction)

- **Signal Integrity Features**
  - Insertion-Loss-to-Crosstalk-Ratio(ICR)
    The insertion-loss-to-crosstalk-ratio (ICR) with five-aggressor differential FEXT meets the extrapolated IEEE 802.3ap specification for 15+Gbps.
  - Differential Impedance
    85Ω configuration and 100Ω configuration are available.

- **Stack Height**
  - 2-piece type
    - With ground plate
      - Headers: FX10#-xP-SV, FX10#-xP-SV1
      - Receptacles: FX10#-xS/-SV
    - Without ground plate
      - Headers: FX10#-xP-SV, FX10#-xP-SV1
      - Receptacles: FX10#-xS/-SV
  - 3-piece type
    - Stacking Height: Header (Mating side)  
      - Interposer: FX10-xIP-xD(Q)-8H
      - Header (Fixed side): FX10#-xP-SV

In cases where the application will demand a high level of reliability, such as automotive, please contact a company representative for further information.

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FX10 Series 15+Gbps 0.5mm pitch Stacking Connectors

General Product Specifications (2 piece type)

<table>
<thead>
<tr>
<th>Item</th>
<th>Requirements</th>
<th>Conditions</th>
</tr>
</thead>
<tbody>
<tr>
<td>1. Insulation resistance</td>
<td>100MΩ min</td>
<td>Measured at 100 V DC</td>
</tr>
<tr>
<td>2. Voltage resistance</td>
<td>No flashover or breakdown</td>
<td>150 V AC applied for 1 minute</td>
</tr>
<tr>
<td>3. Contact resistance</td>
<td>60mΩ max</td>
<td>Measured at 100 mA</td>
</tr>
<tr>
<td>4. Vibration resistance</td>
<td>No electrical discontinuity for 1μs or greater</td>
<td>Frequency: 10 to 55 Hz, amplitude of 0.75 mm in 3 axis directions, 10 cycles each</td>
</tr>
<tr>
<td>5. Shock resistance</td>
<td>No electrical discontinuity for 1μs or greater</td>
<td>Acceleration of 490 m/s², 11ms duration, sine half-wave waveform, for 3 cycles in both directions of each of the 3 axes</td>
</tr>
<tr>
<td>6. Damp heat (Steady state)</td>
<td>Contact resistance of 70mΩ max, insulation resistance of 100MΩ min, no damage, cracks, or parts looseness</td>
<td>Temperature of 40°C, humidity of 90 to 95%, duration 96 h</td>
</tr>
<tr>
<td>7. Temperature cycle</td>
<td>Contact resistance of 70mΩ max, insulation resistance of 100MΩ min, no damage, cracks, or parts looseness</td>
<td>Temperature: -55°C → 15 to 35°C → 85°C → 15 to 35°C Time: 30 min. → 2 to 3 min. → 30 min. → 2 to 3 min. for 5 cycles</td>
</tr>
<tr>
<td>8. Mating Cycles</td>
<td>Contact resistance of 70mΩ max, no damage, cracks, or parts looseness</td>
<td>50 times</td>
</tr>
<tr>
<td>9. Resistance to soldering heat</td>
<td>No melting of resin portion which affects performance</td>
<td>Reflow: At the recommended temperature profile Soldering iron temperature: 360°C for 5 seconds</td>
</tr>
</tbody>
</table>

Note 1: Includes temperature rise caused by current flow.
Note 2: The term storage refers to unused products kept for a long time prior to board mounting. Operating temperature and humidity range are applicable to the non-conducting state after board assembly.
Note 3: Information contained in this catalog represents general requirements for this series. Contact us for the drawings and specifications for a specific part number shown.

Materials / Finish

<table>
<thead>
<tr>
<th>Part</th>
<th>Material</th>
<th>Finish</th>
<th>Notes</th>
</tr>
</thead>
<tbody>
<tr>
<td>Insulator</td>
<td>LCP</td>
<td>Beige</td>
<td>UL94V-0</td>
</tr>
<tr>
<td>Contacts</td>
<td>Phosphor bronze</td>
<td>Header: Contact Area: Gold plating Lead Area: Tin plating</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>Receptacle: Contact Area: Gold plating Lead Area: Flash plating</td>
<td></td>
</tr>
<tr>
<td>Ground plate</td>
<td>Phosphor bronze</td>
<td>Tin plating</td>
<td></td>
</tr>
<tr>
<td>Metal fitting</td>
<td>Phosphor bronze</td>
<td>Tin plating</td>
<td></td>
</tr>
</tbody>
</table>

Product Number Structure

Refer to the chart below when determining the product specifications from the product number.
Please select from the product numbers listed in this catalog when placing orders.

FX10 # - * P / * - SV 1 (**)
**Headers without ground plate**

- **4mm Stacking Height**

---

**Recommended PCB Layout Dimensions (Metal mask)**

Recommended metal mask thickness: 0.15mm

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**Board-to-Board Distance**

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---
Receptacles without ground plate

Recommended PCB Layout Dimensions (Metal mask)

Recommended metal mask thickness: 0.15mm

Note 1: There is no polarity with respect to board mounting for this product.
Note 2: The coplanarity of this product's SMT leads is 0.1mm or less.
Note 3: Please order embossed tape packaged items by the reel.
Note 4: Using multiple connectors between two boards is not recommended.

FX10 Series ● 15+Gbps 0.5mm pitch Stacking Connectors

Receptacles without ground plate

Recommended PCB Layout Dimensions (Metal mask)

Recommended metal mask thickness: 0.15mm

Note 1: Not required in products without guideposts.
**Headers with ground plate**

- **4mm Stacking Height**

---

**Recommended PCB Layout Dimensions (Metal mask)**

- Recommended metal mask thickness: 0.15mm

---

### Table: Recommended PCB Layout Dimensions (Metal mask)

<table>
<thead>
<tr>
<th>Part No.</th>
<th>HRS No.</th>
<th>No.of Contacts</th>
<th>A</th>
<th>B</th>
<th>C</th>
<th>D</th>
<th>E</th>
<th>F</th>
<th>Remarks</th>
</tr>
</thead>
<tbody>
<tr>
<td>FX10A-80P/8-SV(**)</td>
<td>570-0001-5 **</td>
<td>80 8 23.5 18 31.1 26.4 31.5 28.3</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>With guideposts</td>
</tr>
<tr>
<td>FX10A-100P/10-SV(**)</td>
<td>570-0002-8 **</td>
<td>100 10 29.5 24 37.1 32.4 37.5 34.3</td>
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<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>FX10A-120P/12-SV(**)</td>
<td>570-0003-0 **</td>
<td>120 12 35.5 30 43.1 38.4 43.5 40.3</td>
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<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>FX10A-140P/14-SV(**)</td>
<td>570-0004-3 **</td>
<td>140 14 41.5 36 49.1 44.4 49.5 46.3</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>FX10B-80P/8-SV(**)</td>
<td>570-0021-2 **</td>
<td>80 8 23.5 18 31.1 31.5 28.3</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>Without guideposts</td>
</tr>
<tr>
<td>FX10B-100P/10-SV(**)</td>
<td>570-0022-5 **</td>
<td>100 10 29.5 24 37.1 37.5 34.3</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>FX10B-120P/12-SV(**)</td>
<td>570-0023-8 **</td>
<td>120 12 35.5 30 43.1 43.5 40.3</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>FX10B-140P/14-SV(**)</td>
<td>570-0024-0 **</td>
<td>140 14 41.5 36 49.1 49.5 46.3</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

**[Specifications number] -** ✽ ✽ ✽ ✽
(71) : Tray packaging
(91) : Embossed tape packaging

---

**Note 1:** There is no polarity with respect to board mounting for this product.

**Note 2:** The coplanarity of this product’s SMT leads is 0.1mm or less.

**Note 3:** Please order embossed tape packaged items by the reel. (One reel holds 1,000 pieces.)

**Note 4:** Using multiple connectors between identical boards is not recommended.

---

**Cross-hatched portions, totaling n places, indicate the ground circuits.**

**Cross-hatched portions, 2 places on both sides, indicate the metal fittings.**

**The cross-hatched area inside the SMT land may come into contact with the connector contacts and thus care should be taken that the pattern does not extend beyond the SMT land width.**

**Not required in products without guideposts.**
**Headers with ground plate**

- **5mm Stacking Height**

---

**Recommended PCB Layout Dimensions (Metal mask)**

Recommended metal mask thickness : 0.15mm

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**Part No.** | **HRS No.** | **No. of Contacts** | **A** | **B** | **C** | **D** | **E** | **F** | **Remarks** |
---|---|---|---|---|---|---|---|---|---|
FX10A-80P/8-SV1(*1) | 570-0101-0** | 80 | 8 | 23.5 | 18 | 31.1 | 26.4 | 31.5 | 28.3 |
FX10A-100P/10-SV1(*1) | 570-0102-2** | 100 | 10 | 29.5 | 24 | 37.1 | 32.4 | 37.2 | 34.3 |
FX10A-120P/12-SV1(*1) | 570-0103-5** | 120 | 12 | 35.5 | 30 | 43.1 | 38.4 | 43.5 | 40.3 |
FX10A-140P/14-SV1(*1) | 570-0104-8** | 140 | 14 | 41.5 | 36 | 49.1 | 44.4 | 49.5 | 46.3 |
FX10B-80P/8-SV1(*1) | 570-0121-7** | 80 | 8 | 23.5 | 18 | 31.1 | — | 31.5 | 28.3 |
FX10B-100P/10-SV1(*1) | 570-0122-0** | 100 | 10 | 29.5 | 24 | 37.1 | — | 37.5 | 34.3 |
FX10B-120P/12-SV1(*1) | 570-0123-2** | 120 | 12 | 35.5 | 30 | 43.1 | — | 43.5 | 40.3 |
FX10B-140P/14-SV1(*1) | 570-0124-5** | 140 | 14 | 41.5 | 36 | 49.1 | — | 49.5 | 46.3 |

[Specifications number] ••••
(71) : Tray packaging
(91) : Embossed tape packaging

Note 1 : There is no polarity with respect to board mounting for this product.
Note 2 : The coplanarity of this product's SMT leads is 0.1mm or less.
Note 3 : Please order embossed tape packaged items by the reel. (One reel holds 1,000 pieces.)
Note 4 : Using multiple connectors between identical boards is not recommended.

---

**Recommended PCB Layout Dimensions (Metal mask)**

Recommended metal mask thickness : 0.15mm

---

**Note**

1. Cross-hatched portions, totaling n places, indicate the ground circuits.
2. Cross-hatched portions, 2 places on both sides, indicate the metal fittings.
3. The cross-hatched area XXX inside the SMT land may come into contact with the connector contacts and thus care should be taken that the pattern does not extend beyond the SMT land width.
4. Not required in products without guideposts.
Receptacles with ground plate

Unit: mm

<table>
<thead>
<tr>
<th>Part No.</th>
<th>HRS No.</th>
<th>No. of Contacts</th>
<th>A</th>
<th>B</th>
<th>C</th>
<th>D</th>
<th>E</th>
<th>F</th>
<th>Remarks</th>
</tr>
</thead>
<tbody>
<tr>
<td>FX10A-80S/8-SV(*)</td>
<td>570-0201-4 **</td>
<td>80</td>
<td>8</td>
<td>23.5</td>
<td>18</td>
<td>31.1</td>
<td>26.4</td>
<td>31.5</td>
<td>28.3</td>
</tr>
<tr>
<td>FX10A-100S/10-SV(*)</td>
<td>570-0202-7 **</td>
<td>100</td>
<td>10</td>
<td>29.5</td>
<td>24</td>
<td>37.1</td>
<td>32.4</td>
<td>37.5</td>
<td>34.3</td>
</tr>
<tr>
<td>FX10A-120S/12-SV(*)</td>
<td>570-0203-0 **</td>
<td>120</td>
<td>12</td>
<td>35.5</td>
<td>30</td>
<td>43.1</td>
<td>38.4</td>
<td>43.5</td>
<td>40.3</td>
</tr>
<tr>
<td>FX10A-140S/14-SV(*)</td>
<td>570-0204-2 **</td>
<td>140</td>
<td>14</td>
<td>41.5</td>
<td>36</td>
<td>49.1</td>
<td>44.4</td>
<td>49.5</td>
<td>46.3</td>
</tr>
<tr>
<td>FX10B-80S/8-SV(*)</td>
<td>570-0221-1 **</td>
<td>80</td>
<td>8</td>
<td>23.5</td>
<td>18</td>
<td>31.1</td>
<td>31.5</td>
<td>28.3</td>
<td></td>
</tr>
<tr>
<td>FX10B-100S/10-SV(*)</td>
<td>570-0222-4 **</td>
<td>100</td>
<td>10</td>
<td>29.5</td>
<td>24</td>
<td>37.1</td>
<td>37.5</td>
<td>34.3</td>
<td></td>
</tr>
<tr>
<td>FX10B-120S/12-SV(*)</td>
<td>570-0223-7 **</td>
<td>120</td>
<td>12</td>
<td>35.5</td>
<td>30</td>
<td>43.1</td>
<td>43.5</td>
<td>40.3</td>
<td></td>
</tr>
<tr>
<td>FX10B-140S/14-SV(*)</td>
<td>570-0224-0 **</td>
<td>140</td>
<td>14</td>
<td>41.5</td>
<td>36</td>
<td>49.1</td>
<td>49.5</td>
<td>46.3</td>
<td></td>
</tr>
</tbody>
</table>

Note 1: There is no polarity with respect to board mounting for this product.
Note 2: The coplanarity of this product's SMT leads is 0.1mm or less.
Note 3: Please order embossed tape packaged items by the reel. (One reel holds 1,000 pieces.)

Recommended PCB Layout Dimensions (Metal mask)

Recommended metal mask thickness: 0.15mm

Note 1: Cross-hatched portions, totaling n places, indicate the ground circuits.
Note 2: Cross-hatched portions, 2 places on both sides, indicate the metal fittings.
Note 3: Not required in products without guideposts.
FX10 Series ● 15+Gbps 0.5mm pitch Stacking Connectors

### General Product Specifications (3 piece type)

<table>
<thead>
<tr>
<th>Rating</th>
<th>Item</th>
<th>Requirements</th>
<th>Conditions</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>1. Insulation resistance</td>
<td>100MΩ min</td>
<td>Measured at 100 V DC</td>
</tr>
<tr>
<td></td>
<td>2. Voltage resistance</td>
<td>No flashover or breakdown</td>
<td>150 V AC applied for 1 minute</td>
</tr>
<tr>
<td></td>
<td>3. Contact resistance</td>
<td>8mm height : 80mΩ max 9mm height : 85mΩ max 10mm height : 90mΩ max 11mm height : 95mΩ max 12mm height : 100mΩ max 13mm height : 105mΩ max</td>
<td>Measured at 100 mA</td>
</tr>
<tr>
<td></td>
<td>4. Vibration resistance</td>
<td>No electrical discontinuity for 1µs or greater No damage, cracks, or parts looseness</td>
<td>Frequency: 10 to 55 Hz, amplitude of 0.75mm in 3 axis directions, 10 cycles each</td>
</tr>
<tr>
<td></td>
<td>5. Shock resistance</td>
<td>No electrical discontinuity for 1µs or greater No damage, cracks, or parts looseness</td>
<td>Acceleration of 490m/s², 11ms duration, sine half-wave waveform, for 3 cycles in both directions of each of the 3 axes</td>
</tr>
<tr>
<td></td>
<td>6. Damp heat (Steady state)</td>
<td>Contact resistance change : 20 mΩ or less, insulation resistance of 100MΩ min, no damage, cracks, or parts looseness</td>
<td>Temperature of 40°C, humidity of 90 to 95%, duration 96 h</td>
</tr>
<tr>
<td></td>
<td>7. Temperature cycle</td>
<td>Contact resistance change : 20mΩ or less, insulation resistance of 100MΩ min, no damage, cracks, or parts looseness</td>
<td>Temperature: -55°C → 15 to 35°C → 85°C → 15 to 35°C Time: 30 min. → 2 to 3 min. → 30 min. → 2 to 3 min. for 5 cycles</td>
</tr>
<tr>
<td></td>
<td>8. Mating Cycles</td>
<td>Contact resistance change : 20mΩ or less No damage, cracks, or parts looseness</td>
<td>50 times</td>
</tr>
</tbody>
</table>

---

### Materials / Finish

<table>
<thead>
<tr>
<th>Part</th>
<th>Material</th>
<th>Finish</th>
<th>Notes</th>
</tr>
</thead>
<tbody>
<tr>
<td>Insulator</td>
<td>LCP</td>
<td>Black/Gray</td>
<td>UL94V-0</td>
</tr>
<tr>
<td>Contacts</td>
<td>Phosphor bronze</td>
<td>Contact Area: Gold plating</td>
<td></td>
</tr>
<tr>
<td>Ground bar</td>
<td>Phosphor bronze</td>
<td>Ni plating</td>
<td></td>
</tr>
</tbody>
</table>

### Product Number Structure

Refer to the chart below when determining the product specifications from the product number. Please select from the product numbers listed in this catalog when placing orders.

```
FX10 - # IP - 36 DM1 - #H (#)
```

- **1 Series Name**: FX10
- **2 Pin count**: 120, 144, 168 pins
- **3 Connector type**: IP : Interposer
- **4 Number of Diff-pairs**: D : Diff. 100 ohm Q : Diff. 85 ohm (Blank) : Open pin field
- **5 Signal type**: Blank = Standard (all diff pins), M* = Reduced GND pins
- **7 Stacking height**: 8H : 8 to 10mm 8PH : 11 to 13mm
- **6 Pin configuration**: (Blank) : Ni1.5µm + Au0.1µm (03) : Ni1.5µm + Au0.76µm

---

Note 1: Includes temperature rise caused by current flow.

Note 2: The term storage refers to unused products kept for a long time prior to board mounting. Operating temperature and humidity range are applicable to the non-conducting state after board assembly.

Note 3: Information contained in this catalog represents general requirements for this series. Contact us for the drawings and specifications for a specific part number shown.
## Interposer (3piece type)

![Diagram of Interposer](image)

### Specifications

<table>
<thead>
<tr>
<th>Part No.</th>
<th>HRS No.</th>
<th>Signal type</th>
<th>Differential pairs</th>
<th>Single-ended pins</th>
<th>Ground pins</th>
<th>A</th>
<th>Remarks</th>
</tr>
</thead>
<tbody>
<tr>
<td>FX10-168IP-40D-8H(**)</td>
<td>608-0001-3</td>
<td>100Ω</td>
<td>40</td>
<td>4</td>
<td>84</td>
<td>49.1</td>
<td>For 8 to 10mm height</td>
</tr>
<tr>
<td>FX10-168IP-40D-8PH(**)</td>
<td>608-0004-1</td>
<td>85Ω</td>
<td>52</td>
<td>8</td>
<td>56</td>
<td>49.1</td>
<td>For 8 to 10mm height</td>
</tr>
<tr>
<td>FX10-168IP-8H(**)</td>
<td>608-0003-9</td>
<td>Open pin field</td>
<td>0</td>
<td>168</td>
<td>0</td>
<td>For 8 to 10mm height</td>
<td></td>
</tr>
<tr>
<td>FX10-168IP-8PH(**)</td>
<td>608-0006-7</td>
<td>100Ω</td>
<td>32</td>
<td>12</td>
<td>68</td>
<td>43.1</td>
<td>For 8 to 10mm height</td>
</tr>
<tr>
<td>FX10-144IP-32D-8H(**)</td>
<td>608-0007-0</td>
<td>100Ω</td>
<td>32</td>
<td>12</td>
<td>68</td>
<td>43.1</td>
<td>For 8 to 10mm height</td>
</tr>
<tr>
<td>FX10-144IP-32D-8PH(**)</td>
<td>608-0011-7</td>
<td>85Ω</td>
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<td>48</td>
<td>43.1</td>
<td>For 8 to 10mm height</td>
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<tr>
<td>FX10-144IP-44Q-8H(**)</td>
<td>608-0008-2</td>
<td>Open pin field</td>
<td>0</td>
<td>144</td>
<td>0</td>
<td>For 8 to 10mm height</td>
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</tr>
<tr>
<td>FX10-144IP-44Q-8PH(**)</td>
<td>608-0010-4</td>
<td>100Ω</td>
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<td>4</td>
<td>60</td>
<td>37.1</td>
<td>For 8 to 10mm height</td>
</tr>
<tr>
<td>FX10-120IP-28D-8H(**)</td>
<td>608-0013-2</td>
<td>85Ω</td>
<td>36</td>
<td>8</td>
<td>40</td>
<td>37.1</td>
<td>For 8 to 10mm height</td>
</tr>
<tr>
<td>FX10-120IP-28D-8PH(**)</td>
<td>608-0014-5</td>
<td>Open pin field</td>
<td>0</td>
<td>120</td>
<td>0</td>
<td>For 8 to 10mm height</td>
<td></td>
</tr>
<tr>
<td>FX10-120IP-8H(**)</td>
<td>608-0017-3</td>
<td>100Ω</td>
<td>28</td>
<td>4</td>
<td>60</td>
<td>37.1</td>
<td>For 8 to 10mm height</td>
</tr>
<tr>
<td>FX10-120IP-8PH(**)</td>
<td>608-0018-6</td>
<td>Open pin field</td>
<td>0</td>
<td>120</td>
<td>0</td>
<td>For 8 to 10mm height</td>
<td></td>
</tr>
</tbody>
</table>

**Blank**: Contact plating Ni1.5µm+Au0.1µm
**(03)**: Contact plating Ni1.5µm+Au0.76µm

### Stacking height

<table>
<thead>
<tr>
<th>Stacking height</th>
<th>Header (Mating side)</th>
<th>Interposer</th>
<th>Header (Fixed side)</th>
</tr>
</thead>
<tbody>
<tr>
<td>8mm</td>
<td>FX10#-xP-SV</td>
<td>FX10-xIP-xD(Q)-8H</td>
<td>FX10#-xP-SV</td>
</tr>
<tr>
<td>9mm</td>
<td>FX10#-xP-SV</td>
<td>FX10-xIP-xD(Q)-8H</td>
<td>FX10#-xP-SV1</td>
</tr>
<tr>
<td>10mm</td>
<td>FX10#-xP-SV1</td>
<td>FX10-xIP-xD(Q)-8H</td>
<td>FX10#-xP-SV1</td>
</tr>
<tr>
<td>11mm</td>
<td>FX10#-xP-SV2</td>
<td>FX10-xIP-xD(Q)-8H</td>
<td>FX10#-xP-SV1</td>
</tr>
<tr>
<td>12mm</td>
<td>FX10#-xP-SV3</td>
<td>FX10-xIP-xD(Q)-8PH</td>
<td>FX10#-xP-SV1</td>
</tr>
<tr>
<td>13mm</td>
<td>FX10#-xP-SV4</td>
<td>FX10-xIP-xD(Q)-8H</td>
<td>FX10#-xP-SV1</td>
</tr>
</tbody>
</table>
Signal integrity (2 piece type)

● Pin assignment

To match 100 ohm differential impedance and to reduce crosstalk, a staggered GSGSG pin assignment is recommended. (G=ground and S=signal)

Impedance

The differential impedance is 100 +/- 10 ohm for FX10 at 30 ps rise time (20% to 80%).

Propagation delay

The propagation delay is 62 and 67 ps for FX10 of 4mm and 5mm height (with and without GND), respectively.
● Insertion loss
The differential insertion loss crosses 1dB at 10.8 and 9.2GHz for FX10 of 4mm and 5mm height, respectively.

● Return loss
The differential return loss meets the IEEE 802.3ap specification to 20+ and 13.5 GHz for FX10 of 4mm and 5mm height, respectively.
**Near-end crosstalk (NEXT)**
The staggered GSGSG pin assignment results in low differential NEXT between neighboring pairs.

![Graph of NEXT for 4mm (without GND)](image1)

![Graph of NEXT for 5mm (without GND)](image2)

![Graph of NEXT for 4mm (with GND)](image3)

![Graph of NEXT for 5mm (with GND)](image4)

**Far-end crosstalk (FEXT)**
The staggered GSGSG pin assignment results in low differential FEXT between neighboring pairs.

![Graph of FEXT for 4mm (without GND)](image5)

![Graph of FEXT for 5mm (without GND)](image6)

![Graph of FEXT for 4mm (with GND)](image7)

![Graph of FEXT for 5mm (with GND)](image8)
● Insertion-loss-to-crosstalk ratio (ICR)

The insertion-loss-to-crosstalk ratio (ICR) with five-aggressor differential FEXT meets the extrapolated IEEE 802.3ap specification to 10^+ Gbps.
**Signal integrity (3-piece type)**

- **Pin assignment**
  For 100 ohm type interposer, pin assignment shall be GSGSG.
  For 85 ohm type interposer, pin assignment shall be GSSG.

### 1. Differential Impedance
- **100Ω Type**
  (With Ground Bar)

### 2. Differential Impedance
- **85Ω Type**
  (With Ground Bar)

### 3. Open Pin Field Type
- **(No Ground Bar)**

#### Pin Assignment
- **Row A**: Signal Pin, Dedicated Ground Pin, Differential Pair
- **Row B**: Signal Pin, Dedicated Ground Pin, Differential Pair

#### Impedance
- **8mm (85 ohm type)**

#### Insertion Loss
- **8mm (85 ohm type)**

#### Return Loss
The differential return loss meets the IEEE 802.3ap specification to 20 GHz for FX10 of 8mm height.
- **8mm (85 ohm type)**
● Near-end crosstalk (NEXT)

8mm (85 ohm type)

● Far-end crosstalk (FEXT)

8mm (85 ohm type)

● Insertion-loss-to-crosstalk ratio (ICR)

The insertion-loss-to-crosstalk ratio (ICR) with five-aggressor differential FEXT meets the extrapolated IEEE 802.3ap specification to 15-Gbps.

8mm (85 ohm type)
# Embossed Carrier Tape Dimensions

## Headers

<table>
<thead>
<tr>
<th>Insertion Connector</th>
<th>A</th>
<th>B</th>
<th>C</th>
<th>D</th>
<th>E</th>
<th>F</th>
<th>G</th>
</tr>
</thead>
<tbody>
<tr>
<td>FX10#-8P/8-SV</td>
<td>20.2</td>
<td>40.4</td>
<td>44</td>
<td>45.5</td>
<td>50.5</td>
<td></td>
<td></td>
</tr>
<tr>
<td>FX10#-10P/10-SV</td>
<td>26.2</td>
<td>52.4</td>
<td>56</td>
<td>59</td>
<td>64</td>
<td></td>
<td></td>
</tr>
<tr>
<td>FX10#-14P/14-SV</td>
<td>34.2</td>
<td>68.4</td>
<td>72</td>
<td>76.5</td>
<td>81.5</td>
<td></td>
<td></td>
</tr>
<tr>
<td>FX10#-96P-SV</td>
<td>20.2</td>
<td>40.4</td>
<td>44</td>
<td>45.5</td>
<td>50.5</td>
<td></td>
<td></td>
</tr>
<tr>
<td>FX10#-120P-SV</td>
<td>26.2</td>
<td>52.4</td>
<td>56</td>
<td>59</td>
<td>64</td>
<td></td>
<td></td>
</tr>
<tr>
<td>FX10#-144P-SV</td>
<td>34.2</td>
<td>68.4</td>
<td>72</td>
<td>76.5</td>
<td>81.5</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Note: There is no polarity with respect to embossed tape packaging for this product.

## Receptacles

<table>
<thead>
<tr>
<th>Insertion Connector</th>
<th>A</th>
<th>B</th>
<th>C</th>
<th>E</th>
<th>F</th>
<th>G</th>
</tr>
</thead>
<tbody>
<tr>
<td>FX10#-80P/8-SV</td>
<td>20.2</td>
<td>40.4</td>
<td>44</td>
<td>45.5</td>
<td>50.5</td>
<td></td>
</tr>
<tr>
<td>FX10#-100P/10-SV</td>
<td>26.2</td>
<td>52.4</td>
<td>56</td>
<td>59</td>
<td>64</td>
<td></td>
</tr>
<tr>
<td>FX10#-120P/12-SV</td>
<td>34.2</td>
<td>68.4</td>
<td>72</td>
<td>76.5</td>
<td>81.5</td>
<td></td>
</tr>
<tr>
<td>FX10#-96P-SV1</td>
<td>20.2</td>
<td>40.4</td>
<td>44</td>
<td>45.5</td>
<td>50.5</td>
<td></td>
</tr>
<tr>
<td>FX10#-120P-SV1</td>
<td>26.2</td>
<td>52.4</td>
<td>56</td>
<td>59</td>
<td>64</td>
<td></td>
</tr>
<tr>
<td>FX10#-144P-SV1</td>
<td>34.2</td>
<td>68.4</td>
<td>72</td>
<td>76.5</td>
<td>81.5</td>
<td></td>
</tr>
</tbody>
</table>

Note: There is no polarity with respect to embossed tape packaging for this product.

## Reel Dimensions
Recommended Temperature Profile

HRS test Conditions
Test board Glass epoxy 161mm×100mm×1.6mm thick
Solder method : Reflow
Solder composition : Paste,
96.5%Sn/3%Ag/0.5%Cu
Metal mask : 0.15mm thick
Reflow cycles : 2 cycles

The temperature profile is based on the above conditions. In individual applications the actual temperature may vary, depending on solder paste type, volume/thickness and board size/thickness. Consult your solder paste and equipment manufacturer for specific recommendations.

Washing Conditions

Organic Solvent Cleaning

<table>
<thead>
<tr>
<th>Solvent</th>
<th>Room temperature washing</th>
<th>Heated washing</th>
</tr>
</thead>
<tbody>
<tr>
<td>IPA (Isopropyl alcohol)</td>
<td></td>
<td></td>
</tr>
<tr>
<td>HCFC (Hydrochlorofluorocarbon)</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Water Type Cleaning
When using water based cleaning agents (e.g., terpene, alkali saponifiers) make sure the labeling discloses any effect on metals, platings and plastics. Remove any moisture after cleaning. Residual flux or cleaning agents in the contact areas may affect the electrical performance.

Cleaning Precautions
Residual flux or cleaning agents in the contact areas may affect the electrical performance. Please make sure a thorough cleaning operation has been completed.

Connector Handling Precautions

1. Mating lengths and creepage distance
The effective wipe length for this product is 1.1mm for the signal contact and 1 mm for the ground contact. Creepage of the header and receptacle during mating should be within 0.5 mm of the fully mated position.

2. PCB support
Note that boards should not be supported solely by the connectors themselves. Support should be in the form of spacers and screws or other suitable methods to support the boards.

3. Solder repairs
During repair, the flux could wick onto the contact area of the connector and cause reduced contact reliability. In this case, make sure you understand washing conditions before washing is implemented.

4. Miscellaneous
- Note that excessive twisting while inserting or withdrawing connectors will cause damage.
- Slight color differences on the molded items may be noted. However, these color differences will not affect the connector's performance.
Spacer

Spacers are required to support the PWB’s and protect the SMT solder joints.

The recommended spacer height corresponds to the interposer stacking height as shown in the chart below.

<table>
<thead>
<tr>
<th>Stacking height</th>
<th>Recommended spacer height</th>
<th>Remark</th>
</tr>
</thead>
<tbody>
<tr>
<td>4mm</td>
<td>4.3 ± 0.127mm</td>
<td>2 piece type</td>
</tr>
<tr>
<td>5mm</td>
<td>5.3 ± 0.127mm</td>
<td></td>
</tr>
<tr>
<td>6mm</td>
<td>6 ± 0.127mm</td>
<td></td>
</tr>
<tr>
<td>7mm</td>
<td>7 ± 0.127mm</td>
<td></td>
</tr>
<tr>
<td>8mm</td>
<td>8 ± 0.127mm</td>
<td></td>
</tr>
<tr>
<td>9mm</td>
<td>9 ± 0.127mm</td>
<td>3 piece type</td>
</tr>
<tr>
<td>10mm</td>
<td>10 ± 0.127mm</td>
<td></td>
</tr>
<tr>
<td>11mm</td>
<td>11 ± 0.127mm</td>
<td></td>
</tr>
<tr>
<td>12mm</td>
<td>12 ± 0.127mm</td>
<td></td>
</tr>
<tr>
<td>13mm</td>
<td>13 ± 0.127mm</td>
<td></td>
</tr>
</tbody>
</table>

Interposer installation

Position the interposer directly over the mounting header. (Interposers have no polarity.)

Fixed side (black side) of the interposer shall be mated with the mounting header (fixed side).

Do not use SV2, SV3, or SV4 headers on both sides of the interposer. The wiping length on the mating side becomes shorter.

Recommended spacer location

Four spacers located diagonally are required.

Spacers should be located 10 to 30mm from the connector to prevent excessive mechanical loading on the interconnections.

If assembly will be subjected to vibration, spacer should be located to prevent resonance, and additional spacer may be required.

Suggested spacer style is shown below:

Spacer, male-male, M3 thread

Stacking height | Header (Mating side) | Interposer | Header (Fixed side) |
<table>
<thead>
<tr>
<th></th>
<th></th>
<th></th>
<th></th>
</tr>
</thead>
<tbody>
<tr>
<td>8mm</td>
<td>FX10#-xP-SV</td>
<td>FX10-xIP-xD(Q)-8H</td>
<td>FX10#-xP-SV</td>
</tr>
<tr>
<td>9mm</td>
<td>FX10#-xP-SV</td>
<td>FX10#-xP-SV1</td>
<td>FX10#-xP-SV1</td>
</tr>
<tr>
<td>10mm</td>
<td>FX10#-xP-SV1</td>
<td>FX10#-xP-SV1</td>
<td>FX10#-xP-SV1</td>
</tr>
<tr>
<td>11mm</td>
<td>FX10#-xP-SV2</td>
<td>FX10#-xP-SV1</td>
<td>FX10#-xP-SV1</td>
</tr>
<tr>
<td>12mm</td>
<td>FX10#-xP-SV3</td>
<td>FX10-xIP-xD(Q)-8PH</td>
<td>FX10#-xP-SV1</td>
</tr>
<tr>
<td>13mm</td>
<td>FX10#-xP-SV4</td>
<td>FX10#-xP-SV1</td>
<td>FX10#-xP-SV1</td>
</tr>
</tbody>
</table>
**Interposer removal**

The interposer can be removed from the mounting header by hand. (No special tools are needed.) Removal and re-mating of the fixed side can reduce the extraction force of the fixed side due to wear. It is recommend to replace the interposer to a new one once removed.

**Multiple Mating**

**<2-piece type>**

It is not recommended to use multiple 2-piece FX10 connectors on the same PWB.

**<3-piece type>**

FX10 3-piece type has multiple mating capability. If multiple connectors are used on the same PWB, they must be oriented in the same direction. It is not recommended to mix orientations.

**Mating tolerance (3-piece type)**

Due to the floating interposer, FX10 3-piece type can accept mating tolerances of up to ±0.15mm tolerance in the X-axis and up to ±0.15mm in the Y-axis.
FX10 Series

The characteristics and the specifications contained herein are for reference purpose. Please refer to the latest customer drawings prior to use.

The contents of this catalog are current as of date of 12/2016. Contents are subject to change without notice for the purpose of improvements.

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